



Microcross Components to Distribute Everspin Technologies MRAM Products

Microcross to provide access to Everspin MRAM in die form for those customers requiring small form factors

ORLANDO, Florida, February 23, 2016 – Microcross Components (“Microcross”), a global provider of specialty electronic components with a 35-year history in providing authentic, high-reliability products, announced an agreement with Everspin Technologies to distribute Everspin’s industry-leading MRAM products in die and wafer form.

MRAM has become the memory of choice in applications requiring intensive data logging, protection of data in the event of power loss and the ability to operate reliably at high speed over extreme temperatures. MRAM is a non-volatile memory that uses a magnetic state rather than electric charge to store data.

“For years, Microcross has been providing its customers access to the leading edge of technology in die form and our partnership with Everspin and its MRAM technology extends our capability,” notes Tony Hamby, Microcross’ Chief Commercial Officer. “Microcross’ customers operate in the harshest of environments where data integrity and security are critical to mission success and Everspin’s MRAM technology greatly enhances their system reliability.”

“With this agreement our customers now have the ability to use our MRAM technology in die form with the support of industry leader Microcross,” said Scott Sewell, Vice President of Sales and Marketing for Everspin. “Many systems require unique packaging due to space constraints or harsh environments and now customers will be able to confidently design in MRAM.”

Everspin’s family of both parallel asynchronous IO and serial SPI interface products in densities ranging from 256Kb up to 16Mb are available now from Microcross.

About Microcross Components, Inc.

Microcross Components, a leading global provider of distributed and specialty electronic components for aerospace, military, defense and other demanding applications, has operated as a single-source provider of high reliability, state-of-the-art electronics for 35+ years. Microcross’ solutions range from bare die and wafer processing through advanced and custom packaging to leading edge component design and test. Microcross possesses the design, manufacturing, testing and logistics expertise needed to support an application from start to finish. Microcross is certified to ISO9001:2008 and QML MIL-PRF-38535, as well as AS9100. For more information, visit www.microcross.com



About Everspin Technologies, Inc

Everspin Technologies is the worldwide leader in designing, manufacturing, and commercially shipping discrete and embedded Magnetoresistive RAM (MRAM) and Spin-Torque MRAM (ST-MRAM) into markets and applications where data persistence and integrity, low latency, and security are paramount. With over 60 Million MRAM and ST-MRAM products deployed in data center, cloud storage, energy, industrial, automotive, and transportation markets, Everspin has built the strongest and fastest growing foundation of MRAM users in the world. With an intellectual property portfolio of more than 500 active patents and applications, Everspin leads the market in development of both in-plane and perpendicular magnetic tunnel junction (MTJ) ST-MRAM bit cells. Everspin has established high-quality manufacturing worldwide, along with enabling a full turn-key 300mm high-volume foundry partner for advanced technology nodes including 40nm, 28nm and beyond. In addition to launching discrete memory solutions with new densities and advanced interfaces, including the world's first commercialization and volume shipments of ST-MRAM, Everspin is delivering on the company's strategy to proliferate MRAM and ST-MRAM as mainstream embedded memories for use in MCUs, GPUs, DSPs, Application Processors, and ASICs, earning Everspin its description as "The MRAM Company". www.everspin.com